

<div></div>	Die Line File: IDL_AUD005_PROEJECT OVER EAR HEADPHONES		REV A 00
	Artwork File:		
DIE LAYOUT			<div>Business Unit: Core</div> <div>Program Manager: Andrew Camba</div> <div>Packaging Engineer: Matthew Duffy</div> <div>Retail Outside Dimension (Including Hang Tab) L x W x D (in): L x W x D (mm):</div> <div>DIE/MATERIAL SPECS: Material: Please refer to drawing Blank Size (in): 65.053 x 24+3/8 Blank Size (mm): 1652.335 x 619+1/8</div> <div>This dieline works for following skus (if any):</div> <div>Unit: IN/MM Side Shown: PRINT SIDE Flute/Grain: horizontal Tolerance:+/- 1/32" - 0.8mm Drawing Scale 1:1</div> <div>RELEASE DATE: 05/30/2023</div> <div>DIELINE: Intermediate</div> <div>THIS DOCUMENT & THE INFORMATION IN IT ARE THE CONFIDENTIAL PROPERTY OF BELKIN INTERNATIONAL AND MUST NOT BE COPIED, REPRODUCED OR USED IN ANY MANNER WITHOUT THE WRITTEN CONSENT OF BELKIN CORPORATION. IT MUST BE RETURNED UPON REQUEST</div> <div>DO NOT PRINT DIE LINES, PRINTERS NOTES</div>
PRINT SPECS: Color Plates:			Finish:
Notes:			